

# High precision time measurements in future experiments

J. Va'vra, SLAC

J. Va'vra, https://www.slac.stanford.edu/~jjv/activity/Vavra\_Invited\_paper\_La\_Rochelle\_2019.pdf



### **High luminosity drives new timing developments**

ATLAS event after high luminosity upgrade:



Challenge: Connect charged tracks to the correct production vertices

- 4D tracking , which is a combination of <u>Time & Position</u> measurement:

   a) Tracking detector for ATLAS & CMS: ~ 10's of ps & 10's of μm per MIP/pixel.
   b) New RICH DIRC detector applications: ~ 80-100 ps/photon/pixel.
- There is a general push for higher luminosity at LHC, Belle-II, Panda, Electron-ion collider, etc.

#### Examples of high resolution timing at a level of ~30 ps for MIPs, and ~100ps for single photons

**ATLAS High-Granularity Timing Detector (HGTD) with Low Gain Avalanche Diodes (LGAD):** 



#### **TORCH DIRC at LHCb:**



#### **Belle-II iTOP DIRC:**

**EIC DIRC in USA:** 

Anode pickup electrode

Cathode pickup electrodes

Differential signal to front-end electronics

**ALICE-like MRPC TOF counters:** 

**FIT at ALICE:** 











electrically floating

electrically floating

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# Rate capability of various detectors

### **MCP** rate capability

A. Lehmann, Panda, RICH 2010, Cassis, France



- Older MCPs could operate up to ~200-300 kHz/cm<sup>2</sup> at a gain of 10<sup>6</sup>.
- Endcap Panda DIRC MCPs plan to operate rate up to ~2 MHz/cm<sup>2</sup>.
- Belle-II TOP counter MCPs plan to operate at a rate of ~2 MHz/cm<sup>2</sup>.
- LHCb TORCH MCPs plan to operate at a rate of up to ~36 MHz/cm<sup>2</sup>, or ~2 MHz/one micro-pad.

### **MCP QE aging and total charge**

A. Lehmann, RICH 2018 and K. Matsuoka, TIP 2017



#### Belle-II: K.Matsuaoka, TIPP 2017:



- Lehmann & Matsuaoka: Latest Photonis and Hamamatsu MCPs reached ~20 C/cm<sup>2</sup>.
- **Belle-II:** expect total of ~10 C/cm<sup>2</sup>.
- LHCb TORCH: expect total of ~5 C/cm<sup>2</sup>.
- Message: New ALD-based treatment has improved MCP QE lifetime significantly.

#### Maximum rate and charge dose capability of other detectors

#### **ALICE MRPCs:**

Present detector can run at ~500 Hz/cm<sup>2</sup>. New low resistivity MRPCs will run at ~50 kHz/cm<sup>2</sup>.

#### **Diamond (TOTEM):**

This technology is very radiation hard. High rate capability achieved: ~3 MHz/cm<sup>2</sup>.

#### SiPMTs:

Operation of some RICH detectors in single photon regime at  $10^{11}n_{eq}cm^{-2}$  & -30 °C is possible. All SiPMs, even those irradiated up to  $10^{14} n_{eq}/cm^2$ , are "usable" at liquid nitrogen temperature.

#### LGADs (ATLAS UFSD project):

Expect rates up to  $\sim 40 \text{ MHz/cm}^2$ .

Sensors & ASICs will be exposed to  $3.7 \times 10^{15} n_{eq}/cm^2$  and 4.1 MGy (!!!) !!!!

Present test results are very close to this goal.

### **Time measurement**

#### **Timing resolution for leading edge timing**

(Well-known formula to fast electronics designers for a long time)

#### A simple formula: $\sigma_{\text{time}} = \sigma_{\text{noise}} / (ds/dt)_{\text{threshold}} \sim t_{\text{rise-time}} / (S/N)$



- For LGAD detector with  $t_{rise-time} \sim 400 \text{ ps}$ , one needs S/N ~20 get to a ~20 ps regime.
- However, this picture is over-simplified see next slide.

### Many other contributions to timing resolution, which makes timing measurement difficult

**Example of contributions to the timing resolution:** 

 $\sigma_{\text{Total}} \sim \sqrt{\left[ (\sigma_{\text{TTS}} / \sqrt{N_{\text{pe}}})^2 + (\sigma_{\text{pixel}} / \sqrt{12})^2 + \sigma_{\text{Electronics}}^2 + \sigma_{\text{Track}}^2 + \sigma_{\text{to}}^2 \dots \right]}$ 

- $\begin{array}{ll} \sigma_{Electronics} & \mbox{ electronics contribution} \\ \sigma_{pixel} & \mbox{ pixel size} \\ \sigma_{TTS} & \mbox{ single electron transit time spread} \\ \sigma_{Track} & \mbox{ timing error due to track length } L_{path} \end{array}$
- $\sigma_{\text{Time walk}}$  time walk due to pulse height changes
  - start time (often dominated by the bunch length)

+ there are many other possible effects in a large system:

- clock distribution throughout a large system
- cross-talk effects in multi-pixel detectors (ringing in a multi-photon environment)
- baseline oscillation or other instability instability in multi-pixel detectors
- charge sharing in multi-pixel detectors (pixel edge effects)
- chromatic effects
- Unwanted pulse tails
- Calibration
- ground loops, current return, differential vs. single ended readout, etc.

 $\sigma_{to}$ 

Ultimate resolution using single-pixel MCP-PMTs

#### This is the fastest detector to my knowledge

J. Milnes and H. Howorth, Photek Co. info, 2005





Using the simple formula:If we assume S/N ~ 20 $t_{rise time}$  ~66 ps $\sigma_{time}$  ~  $t_{rise time}$  /(S/N) ~3 ps

### MCP-PMT: Single-pixel TOF counter, no amplifier, large Npe

#### K. Inami et al., NIMA560(2006)303

#### Two Hamamatsu R3809U-59-11 MCPs:

- 6 microns MCP hole sizes
- Fused silica radiator+window:10+3 mm
- Single pixel
- MCP Gain ~2x10<sup>6</sup>
- SPC-134, Becker & Hickl GmbH
- Electronics resolution: 4.1 ps
- Npe ~ 70
- Total anode charge: 1.4x10<sup>8</sup> el. !!



A. Ronzhin et al., NIMA795 (2015)288

#### Two back-to-back Photek 240 MCPs:

- 6 microns MCP hole sizes
- Fused silica window: 8 mm
- Single pixel
- MCP Gain ~10<sup>6</sup>
- DRS4 waveform digitizer
- Electronics resolution: 2.0 ps
- Npe ~ 80
- Total anode charge: 8x10<sup>7</sup> el. !!



#### L. Sohl et al., Elba conf., 2018

#### Two Hamamatsu R3809U-50 MCPs:

- 6 microns MCP hole sizes
- Fused silica radiator: 3.2 mm
- Single pixel
- MCP Gain ~ 8x10<sup>4</sup>
- 20 GSa/s scope + CFD algorithm
- Electronics resolution: 2.2 ps
- Npe  $\sim 44$
- Total anode charge: 3-4x10<sup>6</sup> el.



#### • <u>Message:</u> Excellent resolution can be achieved with a single-pixel MCP for MIP signals.

• <u>However, one has to be careful running large anode charges</u> – see next slide.

### Why do I want limit total charge on MCP?

J. Va'vra, MCP logbook #6, page 122, 2010, and https://www.slac.stanford.edu/~jjv/activity/Vavra\_Invited\_paper\_La\_Rochelle\_2019.pdf.

# **Ion feedback (afterpulse fraction) with two old Burle Planacon tubes with 10 µm holes:**



Old Burle Planacon MCP-PMT 85013-501:





- <u>Message</u>: One should limit total charge to ~2-3x10<sup>6</sup>.
- Are the new MCPs behaving better ? see next slide.

Challenges of multi-pixel detectors

# **ALICE MRPC TOF detector**

C. Williams, private communication, and Jaron et al., Nucl.Instr.&Meth A 33(2004)183

#### **ALICE MRPCs:**

#### **Differential input to amplifier:**

#### **TOT pulse height correction:**







- Message #1: Differential design throughout to minimize pick-up, cross-talk, etc.
- Message #2: Time-over-threshold pulse height correction works if pulse shapes are "clean".
- Message #3: NINO electronics provides a low power consumption (40 mW/channel; 1ns-peaking time, 8 ch./chip).
- Message #4: ALICE timing resolution was limited by  $t_0$  resolution =>  $\sigma_{\text{Total ALICE }\sigma\text{ystem resolution}}$ : ~60 ps.

#### • New R&D MRPC in progress:

a) ALICE is doing R&D with lower resistivity 400 μm-thick glass, allowing to build 20-gap MRPC capable of rate up to ~50 kHz/cm<sup>2</sup>
b) sPHOENIX at BNL is doing R&D using 2.8 GHz differential preamp LMH 6881 and DRS4 digitizer (M. Chiu).

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### How to connect to Planacon MCP-PMT ?

In principle, MCP is a simple device, but....:



The issue is how to connect to it ? Various schemes which were tried:



- MCP is inherently a single-ended device, which invites a possible pick-up problems. One needs a good RF-shielded box around the device to avoid noise on the ground reference.
- Early Planacon models had unwanted capacitances, inductances, ground return issues, and low BW connectors, which contributed to cross-talk, pulse shape distortions, ringing, fake hits, etc.
- Good news: There is a progress. See appendix.

### **SLAC 1-st FDIRC prototype with 320-pixels in MCPs**

SLAC effort: NIMA 553 (2005) 96

#### **Old Burle Planacon:**



**SLAC Amplifier based on Elantek 2075:** Voltage gain of ~130x, and a rise time of ~1.5ns.





#### Single photons from laser:



#### SLAC CFD (32 ch./board):



#### **Single pixel timing resolutions with Planacon MCP:**



• <u>Message:</u> This was still one of the best timing performance of any large RICH detector system with MCPs.

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### **Cross-talk in early version of Planacon MCP 85011-501**

J.Va'vra, MCP-PMT log book #1, p.81, 2005



4 ns/div & 50 mV/div & 5 mV/div

**Old Burle Planacon:** 





#### **Elctronics used in this test:**

Total voltage gain of 130x = Elantek 2075 amp. 13x + Phillips amp. 10x



All 64 pixel instrumented

Ringing if too many photons arrive at the same time



- Message: The cross-talk was very complicated geometrically on the old Planacon.
- New MCPs behave better progress after 15 years ! See appendix.

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### **1024 pixel Burle Planacon – available already in 2005**

J. Va'vra, https://www.slac.stanford.edu/~jjv/activity/Vavra Photon detector studies.pdf, 2005, and D. Brasse, Workshop on timing detectors, Clermont, 2010

#### 1) FDIRC at SLAC:

#### Burle Planacon 85021-600 with 1024 pixels:



- Small margin around boundary
- 1024 pixels (32 x 32 pattern)
- Small pixel size: ~1.4mm x 1.4mm
- Pitch: 1.6 mm
- Bottom MCP-to-anode dist.: 5.2 mm



Laser scan:



#### 2) **LPET:** David Brasse: read every pixel (MCP coupled to matrix of LYSO crystals)

#### Planacon 85022-600 (Jeff DeFazio):







Point resolution radius ~0.4 mm

Bottom MCP-to-anode dist.: **3.6 mm** 

• Message: In retrospect, we at SLAC, could have chosen 8-channel NINO ASIC to readout every pixel.

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# Several large physics applications with MCP-PMTs

### **Endcap Panda DIRC: Photonics MCP with TOFPET electronics**

Panda Endcup DIRC TDR, 2019, and Jeff DeFazio, private communication



Panda Endcap DIRC readout:



#### New Photonis MCP for Endcap Panda:



- MCP has 0.4 mm x 17 mm anode pixels.

- 3 rows x 100 strip configuration.
- MCP-Anode gap = 0.625 mm
- Anode strips are grounded by electronics.
- tube does not have a ground plane (Jeff DeFazio)
- Goal: TTS resolution of ~100ps; presently they got ~320 ps with negative MCP pulses.
- Problem: TOPFET ASIC was designed for positive pulses, i.e. it works well with SiPMTs. There is an effort to talk to company to provide a modification of the ASIC to work with negative MCP pulses.
- <u>Message:</u> TOPFET2 ASICS is using time-over-threshold timing, it is cheap, electronics has low mass, it is radiation hard and has low power consumption (<10mW/ch).

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### **Belle-II: TOP DIRC counter waveform digitizing electronics**

Work led by Gary Varner, Univ. of Hawaii, details in D. Kotchetkov et al., ArXiv:1804.10782, 2018

**DIRC TOP counter principle (450mm wide x 2600 mm long):** 



- **IRSX** waveform digitizer: 2.7 GSa/sec, an equivalent to a cheap scope on every pixel.  $\mathbf{O}$
- Amplifier gain: ~120x. They slowed down the risetime to have 2 samples on leading edge.  $\mathbf{O}$
- **Message:** The total power consumption is very high: ~570 mW/channel !  $\bullet$

### **Belle-II: TOP counter SL-10 MCP-PMT present results**

M. Bessner et al., Submitted to NIMA, 2019 and D. Kotchetkov et al., ArXiv:1804.10782, 2018

#### HPK SL-10 16 pixel MCP:



- 16 pixels (4 x 4)
- 5.3mm x 5.3mm pixel size

### This MCP is capable of excellent TTS resolution:



#### Bench laser test TTS resolution with final IRSX electronics:



- Because of a large background, MCP gain had to be lowered to ~3x10<sup>5</sup>. As a result of this and other effects, the single photon timing resolution in Belle-II is presently: 80-120ps.
- Max photon rate is kept < 4 MHz/MCP. Some non-ALD coated MCPs will have to be replaced in 2020.

### **LHCb: TORCH TOF MCP-PMTs**

N. Harnew, RICH 2018, J.S. Lapington et al., NIMA 695(2012)78, T.M. Conneely et al., JINST, May 2015 and S. Bhasin et al., to be published in NIM



**Photek MCP:** 

- Challenge #1: Required single photon resolution: ~70 ps/photon and ~10-15ps/track. •
- Challenge #2: Expected rates at LHCb: 10-40 MHz/cm<sup>2</sup>, and anode charge doses up to ~5C/cm<sup>2</sup>. • Aging tests with Phase-I MCP: good up to  $\sim 3C/cm^2$  only at present.
- Message #1: TOT timing with 32-channel NINO ASIC works well, although calibration is complicated.  $\mathbf{O}$

### **Si detectors**



### **SiPMTs radiation hardness is an issue for RICH detectors**

Nakamura, JPS meeting, 2008, M. Calvi et al., NIMA 922(2019)243, C.Woody, EIC PID workshop, 2019, and B. Biro et al., arXiv:1809.04594, 2019



- <u>Message #1</u>: High energy protons and neutrons produce the most damage. Damage from thermal neutrons is observed only at high doses. Gammas produce comparatively lower damage.
- <u>Message #2</u>: Lower temperature can reduce noise rate caused by the neutron damage. All SiPMs, even those irradiated up to 10<sup>14</sup> n<sub>eq</sub>/cm<sup>2</sup>, are "usable" at liquid nitrogen temperature. Operation for RICH detectors in single photon regime at 10<sup>11</sup>n<sub>eq</sub>cm<sup>-2</sup> and -30 °C is possible.

### **EIC R&D on ARICH: SiPMTs noise rate = f(temperature)**

C.P. Wong et. al., NIM A 871, 13 (2017)



• Hamamatsu SiPMT 16 x 16 matrix with 3 mm x 3 mm pixel sizes; ~100ps timing is possible.

• <u>Message</u>: Low temperature clearly helps to reduce the room temperature noise.

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### **ATLAS Endcap Low Gain Avalanche Diodes**

H. Sadrozinski, private communication, ATLAS technical proposal, 2019, and

G. Paternoster, https://indico.cern.ch/event/803258/contributions/3582777/attachments/1963858/3265168/203-Arcidiacono-UFSDstatus.pdf

R. Arcidiacono, https://indico.cern.ch/event/803258/contributions/3582956/attachments/1963922/3265196/362 Paternoster HSTD12-2.pdf

**Present design have a region of no gain:** LGAD sensors, ASICs, cooling and connection package: **ATLAS UFSD Endcap:** gain layer JTE JTE gain layer FLEX cable no-gain area ~70 µm p-Si Endcan HV wire bonding Modules assembly n++ calorimeter wall plate at inner ring Electrical components Outer ring Position and time are determined ervice feedthroug & cooling lines) by amplitude-weighted centroid -Back cover LGAD 2x4 cm<sup>2</sup> using four pads Cooling/support plate 2 ASICS **Present design:** Pitch: 1.3 mm Bump bonding 12 cm < r < 60cm **Gap:** ~ 70µm Not to scale 7888 sensor modules ASIC wire bonding Fill factor: ~90%

- Bench tests: Very good timing and position resolution results using a laser ( $\sigma \sim 10$ 's of ps & 10's of  $\mu$ m).
- Radiation damage: They reached ~3x10<sup>15</sup> n<sub>eq</sub>/cm<sup>2</sup> and 4 MGy, i.e., very close to the final goal. (1 MGy = 100 Mrads !!).
- Two ASICs, ALTIROC (ATLAS) and ETROC (CMS) under development.
- Message: There seems to be a real progress.

Periphera on-detecto electronic

### **Gas detectors**

# **Gasous detectors: Timing with Micromegas**

Y. Giomataris, private communication, and J. Bortfeldt et al., arXiv:1901.03355, 2019



- Pixel size: ~1cm<sup>2</sup> area
- Photocathodes: CsI or DLC (diamond-based photocathode)
- Gas: 80% Ne+10% CF<sub>4</sub>+10% C<sub>2</sub>H<sub>6</sub>
- 3 mm MgF<sub>2</sub> window/radiator
- Cividec amp 1-2 GHz BW, and SAMPIC waveform digitizer or 20 GSa/s LeCroy scope
- CsI photocathode: ~24 ps/MIP (150 GeV/c muons), ~76 ps for single photoelectrons !! Mean number of photoelectrons with CsI: ~10 per/MIP.
- Diamond photocathode: ~40 ps/MIP with 97% det. eff.; need a factor of 3 improvement of QE.
- <u>Message:</u> Gaseous detectors are not dead yet.

# Conclusions

• There has been a real progress in developing 4D LGAD detectors hoping to achieve a position resolution of 10's of µm and 10's of ps per MIP.

• Similarly photon detectors were developed providing ~100 ps per single photon with very small-pixel sizes.

• But future will tell if the promissed timing resolution, which is inherently a very sensitive analog quantity, can be achieved in large background environment and in very large detector applications. It is very challenging task.

# Appendix

#### Maximum rate and charge dose capability

<b>MRPC</b> (ALICE): System MIP resolution of ~60 ps/MIP and rate capability of ~500 Hz/cm <sup>2</sup> .	
New R&D: MIP rate up to $\sim 50 \text{ kHz/cm}^2$ with a new low resistivity glass are under study.	

 MCPs: MIP timing resolution of <10 ps/MIP with a single-pixel MCP achieved. Single photon timing resolution of ~30-100 ps/photon achieved. Endcap DIRC in Panda: expect rates up to ~1 MHz/cm<sup>2</sup> for single pe's @gain of 10<sup>6</sup>. TORCH at LHCb: expect rates up to ~40 MHz/cm<sup>2</sup> !! Panda R&D: anode charge dose up to ~20 C/cm<sup>2</sup> using single pe's with Photonis MCP. TORCH: The 1-st generation of Photek MCPs reached ~3-4 C/cm<sup>2</sup>. The latest Hamamatsu MCPs almost reached ~20C/cm<sup>2</sup>.

**Diamond (TOTEM):** MIP timing resolution of ~80 ps/MIP achieved.

This technology is very radiation hard.

High rate capability achieved: ~3 MHz/cm<sup>2</sup>.

SiPMTs: MIP timing resolution of ~13 ps achieved in a beam test. Significant noise increase after ~10<sup>10</sup> neutrons/cm<sup>2</sup>. Cooling helps.

LGADs (ATLAS UFSD project):

MIP timing resolution of ~30 ps/MIP, and ~16 ps/MIP for tandem of three achieved. Expect rates up to ~40 MHz/cm<sup>2</sup>.

Sensors & ASICs will be exposed to  $3.7 \times 10^{15} n_{eq}/cm^2$  and 4.1 MGy (!!!) in ATLAS !!!! Present test results: OK up to  $3 \times 10^{15} n_{eq}/cm^2$  and 4 MGy.

Micromegas (CsI): Timing resolution of ~24 ps/MIP and ~76 ps/photon achieved in a beam test.

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# **Electronics for the best timing result**



- Ortec 9327 Amp/CFD can reach  $\sigma_{\text{Electronics}} \sim 2$  ps resolution, if one avoids TAC electronics.
- <u>DRS4</u> waveform digitizer can reach  $\sigma_{\text{Electronics}} < 1$  ps for very small delay between start & stop.
- <u>20 GSa/s scope</u> with CFD algorithm can reach  $\sigma_{\text{Electronics}} \sim 2 \text{ ps.}$
- <u>Message:</u> If your electronics contributes ~2 ps to the resolution, you are doing very well.

### Ion feedback in new MCPs, ALD-coated, Npe=1

A. Lehmann, private communication, April 22, 2018



- Photonis XP85112 MCP-PMT performs well at a total charge of ~3x10<sup>6</sup>
- Hamamatsu R13266 sees an increase in the rate already at a total charge of ~1.5x10<sup>6</sup>.

# Cross-talk in Multi-pixel MCPs

### FIT group at ALICE: Modification of Planacon MCP 85012

Y.A. Melikyan on behalf of ALICE, RICH 2018, MCP modifications done by Jeff DeFazio, Photonis.



• <u>Message:</u> A modification of 64-pixel Planacon XP85012 included:

(a) reduced number of pixels from 64 to 4 (SMA connectors),

- (b) add two boards,
- (n) improved the HV ground return and
- (d) increased a distributed capacitance along MCP edges.
- Goal of FIT: Timing resolution  $\sigma \sim 30$  ps/track

#### FIT detector concept to detects MIPs:



### Panda R&D: Latest update on ringing of new 64-pixel Planacon

Albert Lehman, private communication, May 7, 2019, and Jeff DeFazio, private communication,



#### **New features** (from Jeff DeFazio) :

- New connector.
- Smaller anode-ground capacitance.
- Better ground return.
- Tube has the ground plane.
- (Jeff thinks it helps to reduce ringing).

#### • <u>Message:</u> Latest Photonis MCP (#9002150) has much better ringing performance.

## **Ringing in early version of Planacon MCP vs. MaPMT**

J. Va'vra, FDIRC logbook "Beam test Focusing\_DIRC\_3.pdf", p.53, 2006



Scope trigger: Pilas laser

- Message: Amplitude of ringing increases with number of photons hitting MCP. Had to increase the  $\mathbf{O}$ discriminator threshold to avoid fake hits.
- H-8500 MaPMT with the same electronics was OK.  $\mathbf{O}$ 2/25/20 J. Va'vra, INSTR20.

Novosibirsk, 2020

# **MCPs in magnetic field**

#### Endcap Panda: MCP charge footprint in magnetic field can be very small

J. Rieke et al, JINST 11, 2016, and Panda Endcup DIRC TDR, 2019



New Photonis MCP for Endcap Panda:



- MCP has 0.4 mm x 17 mm anode pads.
- 3 rows x 100 strip configuration.
- MCP-Anode gap = 0.625 mm
- tube does not have a ground plane

#### • Message: A magnetic field of only ~0.1 T will reduce the charge footprint to ~15µm !!

### MCP gain in magnetic field

#### A. Lehman, RICH 2018, Moscow:







- ALD tubes seem to show faster gain drop in B-fields than non-ALD tubes !
- Photonis 9002108: gain drop by a factor of 2 at 1 Tesla, at 0 deg.
- Hamamatsu YH0250: gain drop by a factor of 4 at 1 Tesla, at 0 deg.
- Argonne ALD-coated MCP: gain drop by a factor of more than 10 at 1 Tesla, at 0 deg.

#### Ion feedback in MCP = f(B)

J. Va'vra, Log book #7, 2009



• <u>Message:</u> No increase in the ion feedback observed within my errors.

FDIRC development at SLAC



### Can one do timing with low total charge ?

J. Va'vra, MCP log book #7, 2012, NIMA 629 (2011)123, and NIMA 606 (2009) 404



#### 2 Burle old Planacon 10µm MCP-PMT 85013-501:

(4 pixels ganged together, others grounded)



Pulses from Planacon 85013-501 with HPK C5504-44 amp. with a gain of 63x :



- Low gain ~2x10<sup>4</sup>, vary Npe (1-100)
- Total charge: ~8x10<sup>5</sup> for Npe ~40
- For Npe ~ 40 pe, we reached ~14 ps.
- For Npe ~80, one could reach ~10ps.

• <u>Message</u>: For TOF application, one can reach a good resolution even at low gain if Npe ~40-80. 2/25/20 J. Va'vra, INSTR20, Novosibirsk, 2020 46

# Single pe MCP pulses, no amplifier

SLAC effort: J.Va' vra, log book #3, p.23, 2006

#### **Burle Planacon MCP-PMT**

(85013-501):



Using our simple formula:
$$\sigma_{noise} \sim 0.4 \text{ mV}$$
 $S \sim 8 \text{ mV}$  $S/N \sim 8/0.4 \sim 20$  $t_{rise time} \sim 150 \text{ ps}$  (with a better scope) $\sigma_{time} \sim t_{rise time} / (S/N) \sim 7-10 \text{ ps}$ 

- 10 µm MCP hole dia.
- Gain ~10<sup>6</sup>
- 64 pixels, pad size: 6 mm x 6 mm (ground all pads except four)
- Ganging 4 pixels together increases a capacitance.
- PiLas laser is used as a scope trigger



• That told me that one can reach a very good resolution with this MCP

### A good TTS resolution even with slower electronics

SLAC effort: J.Va'vra, log book 3, p. 27, 28 & 37, 2006, and NIMA 572 (2007) 459

#### Planacon 85013-501 single electron pulses with Hamamastu 63x amplifier C5504-44 :





Hamamatsu C5594-44 amplifier

1.5 GHz BW, 63x gain, 2.8kV



- 10 µm MCP hole diameter
- Gain ~10<sup>6</sup>, Npe = 1
- 64 pixels, pad size: 6 mm x 6 mm. (single pixel used)
- $\sigma_{\text{TTS}} < \sqrt{(32^2 \sigma_{\text{Laser}}^2 \sigma_{\text{Electronics}}^2)} \sim 27 \text{ ps}$
- Philips 715 CFD, Pilas laser (635nm).
- LeCroy TDC 2248



~0.4 GHz BW, 200x gain + 6dB, 2.8kV



• One can obtain a good TTS resolution even with a slower amplifier, if one has a good S/N ratio, and one tunes CFD discrimination carefully.

#### **MCP-to-cathode distance - a way to eliminate tail**

SLAC effort: NIMA553(2005)96



MCP-to-Cathode distance ~0.85 mm

5.5

100 90 80

50

40 30

20

effic 70 el. 60

**Penalty: the efficiency drops to zero half way through all edge pads.** •



### **Pixel edge effects in MCP timing**

SLAC effort: NIMA 553(2005)96-106

Scan of timing resolution on one 5mm x 5mm pixel with single photoelectrons:



- Pixel edges and corners have worse timing resolution due to charge sharing.
- In principle, it can be corrected if one has knowledge of a photon entry. But that entry point is usually not known.

# **LAPPD MCPs**

### LAPPD 8"x8" MCP detectors with strip readout

M.J. Minot et al., http://www.incomusa.com/mcp-and-lappd-documents/, 2/6/2019

#### **LAPPD** detector with strips:



#### **Strips: Single pe pulses** (LAPPD #25):



#### **Strips: TTS resolution** (LAPPD #25):



Strip cross-talk problem can be calculated, in principle: H. Grabas, LAPPD simulation study at U. of Chicago/Saclay, May 2012)



Using a simple formula:
S/N ~ 15
t <sub>rise time</sub> ~850 ps
$\sigma_{time} \sim t_{rise time}$ /(S/N) ~60 ps

- Generation-I detectors: Strip line readout is now commercially available from Incom, Inc.
- For many low rate applications this is an excellent choice.

#### LAPPD 8"x8" MCP detectors with pixel readout

Angelico et al., NIMA 846 (2017) 75

#### LAPPD detector concept with capacitively coupled pixels:



#### **Pixels:** capacitive vs. direct coupling pulses:



- Generation- II detectors: (a) ceramic body, (b) capacitive coupling to external PCB board.
- This concept is still in R&D stage and detectors are not yet available.
- See appendix for more info.

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### Si detectors: High gain SiPMTs

A. Rozhnin et al., Fermilab, Talk at Picosecond timing workshop, Arlington, Oct. 5-7, 2015

#### Start: SiPMT, Stop: Photek-240 MCP-PMT

- SiPMT: 3x3mm<sup>2</sup>
- 6 µm holes MCP
- 3 cm-long Fused silica radiator
- No extra radiator used on MCP, only
- 8mm-thick window
- Fast amplifier on SiPMT
- DRS4 digitizer



**8 GeV/c e<sup>-</sup> beam** (distance between two detectors: 7.12 meters)



• Test achieved  $\sigma_{\text{SiPMT}} \sim 13 \text{ ps resolution per MIP.}$  $(\sigma_{\text{SiPMT}} \sim \sqrt{[14.5^2 - (8.3/\sqrt{2})^2]} \sim 13 \text{ ps})$ 

### **Timing + position + calorimeter + PIN diode**

A. Ronzhin et al., Fermilab, SLAC talk, 2017



• Si-PIN diode can achieve pretty good timing resolution in a calorimeter application.

### **ATLAS: Low Gain Avalanche Diodes in test beam**

Cartiglia et al., ArXiv:1608.08681, 2017

- Pixel size: 1.3mm x1.3mm x ~45  $\mu m$  thick
- AD from CNM
- Gain ~ 20 @ 200V on AD
- Cividec 100x amp., 1-2 MHz BW, CFD
- 20 GSa/sec (50 ps bins)



 $\label{eq:time_states} \begin{array}{l} \underline{\text{Using a simple formula:}} \\ t_{\text{rise time}} \sim 400 \text{ps} \\ \text{S/N} \sim 20 \\ \sigma_{\text{time}} \sim t_{\text{rise time}} \, / (\text{S/N}) \, \sim \!\! 20 \, \text{ps} \end{array}$ 



• Test beam achieved:  $\sigma_{time} \sim 34$  for a single sensor, and  $\sim 16$  ps with a tandem of 3 sensors.

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2/25/20
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### **SiPMTs for RICH detectors with TOPFET2 ASIC**

#### TTS resolution with SiPMT and TOPFET was ~100 ps:



R. Bughalo et al., Talk at IEEE/NSF, Atlanta, 2017

- SiPMT: 5x5mm<sup>2</sup>
- SiPMT: HPK S31361-3050
- 64 channel ASIC
- Low power: 5-8 mW/ch
- ps laser (405 nm)





- TOFPET ASIC was developed for Time-of-Flight Positron-Electron Tomography.
- Test achieved  $\sigma_{siPMT} \sim 90-100$  ps resolution per single photon at 7.5V overvoltage.
- Lesson #??: Lower power consumption (5-8 mW/ch.)

### Maximum rate and charge dose capability

J. Va'vra, https://www.slac.stanford.edu/~jjv/activity/Vavra\_Invited\_paper\_La\_Rochelle\_2019.pdf

Detector	Experiment or beam test	Maximum rate	Maximum anode charge dose	Timing resolution	Ref.
MRPC presently	ALICE	~500 Hz/cm <sup>2</sup> *** (tracks)		~60 ps/track (present)***	[4]
MRPC after upgrade	ALICE	Plan: ~50 kHz/cm <sup>2</sup> ** (tracks)		Plan: ~20 ps/track	[4]
MCP-PMT	Beam test			$< 10 \text{ ps/track}^*$	[7,8,9]
MCP-PMT	Laser test		1 - C. O. C L.	~27 ps/photon *	[14]
MCP-PMT	PANDA Barrel test	10 MHz/cm <sup>2</sup> * (laser)	$\sim 20 \text{ C/cm}^2$ *		[11]
MCP-PMT	Panda Endcap	~1 MHz/cm <sup>2</sup> ** (photons)			[28]
MCP-PMT	TORCH test		$3-4 \text{ C/cm}^{2*}$	~90 ps/photon *	[27]
MCP-PMT	TORCH	10-40 MHz/cm <sup>2</sup> ** (photons)	5 C/cm <sup>2</sup> **	~70 ps/photon **	[24-27]
MCP-PMT	Belle-II	< 4MHz/MCP **** (photons)		80-120 ps/photon***	[23]
Low gain AD	ATLAS test	~40 MHz/cm <sup>2</sup> ** (tracks)	1	~ 34 ps/track/single sensor *	[34,35]
Medium gain AD	Beam test			< 18 ps/track *	[39]
Si PIN diode (no gain)	Beam test (electrons)			~23 ps/32 GeV e <sup>-</sup>	[8]
SiPMT (high gain)	Beam test – quartz rad.		$< 10^{10}$ neutrons/cm <sup>2</sup>	$\sim$ 13 ps/track *	[8]
SiPMT (high gain)	Beam test - scint. tiles		$< 10^{10}$ neutrons/cm <sup>2</sup>	< 75 ps/track *	[41]
Diamond (no gain)	TOTEM	$\sim$ 3 MHz/cm <sup>2</sup> * (tracks)		~ 90 ps/track/single sensor *	[36]
Micromegas	Beam test	$\sim 100 \text{ Hz/cm}^2$ (tracks)	1	~24 ps/track *	[31,32,40]
Micromegas	Laser test	$\sim$ 50 kHz/cm <sup>2</sup> * (laser test)		~76 ps/photon *	[31,32,40]

Measured in a test

\*\* Expect in the final experiment

\*\*\* Status of the present experiment